Rambus to Present at the Morgan Stanley Semiconductor and Systems Conference

LOS ALTOS, Calif., Feb 21, 2003 -- Rambus Inc. (Nasdaq:RMBS), a leading developer of chip-to-chip interface products and services, will present at the Morgan Stanley Semiconductor and Systems Conference on March 5, 2003 at 8:30 a.m. Pacific Time.

This event will be available through a webcast and accessed at Rambus' Investor Relations web site at www.rambus.com. The presentation will be available on Rambus' IR web site for one week following the event.

About Rambus Inc. Rambus is a leading provider of chip-to-chip interface products and services. The company's breakthrough technology and engineering expertise have helped leading chip and system companies to solve their challenging interface problems and bring industry-leading products to market. Rambus' interface solutions can be found in hundreds of computing, consumer electronic and networking products. Additional information on Rambus and its technology is available at www.rambus.com.

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